

## **Advanced Product / Process Change Notice**

Date: Aug. 6, 2014

APCN No.: Z200-APCN-DM201408-01-P

Change Title: 16Mx16 SDR/DDR technology migration from 65 to 46nm Change item: ☑ Design ☐ Raw Material ☐ Wafer FAB ☐ Package Assembly ☐ Testing ☐ Others: Affected Product(s): W9825G6JH, W9425G6JH(16Mx16 DDR/SDR with 65nm technology) Description of Change(s): Technology migration (65nm → 46nm) for 16Mx16 SDR/DDR. Reason for Change(s): According to Winbond product roadmap, launch new 16Mx16 SDR/DDR with 46nm technology. Impact of Change(s): (positive & negative) Form: No Change Fit: No Change Function: No Concern (Compatible between 65nm and 46nm) Reliability: On-going Hazardous Substances: No Concern (Please refer to Attachment I) Qualification Plan/ Results: The qualification is in progress and expected come out on September /11 / 2014. Implementation Plan: □ Date Code: \_\_\_\_\_ onward □ Lot No.: \_\_\_\_ onward ⊡ Proposed first ship date: <u>September/ 30 /2014 (schedule)</u>. The follow-up disposition of 65nm 16Mx16 SDR/DDR: 1) The date of Last-buy orders for the 65nm 16Mx16 SDR/DDR: December. 31, 2014. 2) The last shipment date of the 65nm 16Mx16 SDR/DDR: March ,31, 2015. Originator:(QA Responsible: (QA Approval:(QRA Yu-Sung, cheng Sec. Manager) Dept. Manager) Director) Name: Betty Huang TEL:886-3-5678168 (ext.86549) FAX: 886-3-5796124 Contact for Questions & Address: #539, Sec. 2, Wenxing Rd., Jhubei City, Hsinchu County 302, Taiwan Concerns E-mail: <u>Hyhuang8@winbond.com</u>



## **Customer Comments:**

Note: Please sign this notice, and return to Winbond contact within 30 days. If no response is received within 30 days, this Change Request will be assumed to meet your approval.

■ Approval	■ Disapproval	□ Conditional Approval :
Date:		
Dept. name:		
Person in charge	e:	<u>.</u>



## Table 1 The part no comparison table

Product	65nm Part No	46nm Part No
16Mx16 SDR TSOP54	W9825G6JH	W9825G6KH
16Mx16 DDR TSOP66	W9425G6JH	W9425G6KH